

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3290007

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KEI CHENG	12/16/2014
RECEIVING PARTY DATA		
Name:	WORLD WIDE STATIONERY MFG. CO., LTD.	
Street Address:	19/F., KOON WAH MIRRORS FACTORY	
Internal Address:	3RD INDUSTRIAL BUILDING, 5-9 KA HING RD.	
City:	KWAI CHUNG, NEW TERRITORIES	
State/Country:	HONG KONG	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14504069
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	WWSM 2649.US (DSS)	
NAME OF SUBMITTER:	DEBRA S. STAAS	
SIGNATURE:	/Debra S. Staas/	
DATE SIGNED:	03/31/2015	
Total Attachments: 3		
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ASSIGNMENT

WHEREAS, I, Kei CHENG of Hong Kong, China have invented an improvement in RING BINDER MECHANISM (WW/NP1302; WWSM 2648.US) and have executed an application for a United States patent based thereon assigned Serial No. 14/504,069, filed October 1, 2014, and an application filed in the People's Republic of China, Serial No. 201310530283.6, filed October 31, 2013, and an application filed in the People's Republic of China, Serial No. 201320680976.9, filed October 31, 2013;

AND, WHEREAS, World Wide Stationery Mfg. Co., Ltd. of Hong Kong, China, a corporation duly organized and existing under and by virtue of the laws of China (hereinafter referred to as "ASSIGNEE") is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one dollar and other good and valuable consideration, receipt of all of which is hereby acknowledged, I have agreed to and do hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto in and to said invention, said United States application, any other United States applications (including provisional, non-provisional, divisional, continuing, or reissue applications) based in whole or in part on said United States application or in whole or in part on said invention, the aforesaid Chinese application and any other Chinese applications based in whole or in part on said Chinese application, and any other applications in any country based in whole or in part on either or both of the aforesaid United States and Chinese applications or in whole or in part on

said invention, and any and all patents (including extensions thereof) of any country which have been or may be granted on any of the aforesaid applications or on said invention or any part thereof;

TO BE HELD AND ENJOYED by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me had no sale and assignment of said interest been made;

AND I hereby authorize and request the Director of the United States Patent and Trademark Office of the United States of America to issue any and all United States patents which may be granted upon said United States applications or any of them, or upon said invention or any part thereof, to said ASSIGNEE;

AND I hereby agree for myself and for my heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

AND I hereby covenant for myself and my legal representatives, and agree with said ASSIGNEE, its successors and assigns, that I have granted no right or license to make, use or sell said invention, to anyone except said ASSIGNEE, that prior to the execution of this deed my right, title and interest in said invention had not been otherwise encumbered, and that I

have not executed and will not execute any instrument in
conflict herewith.

IN WITNESS WHEREOF, I have hereunto set my hand.

16/12/14

Date

鄭琦

Kei CHENG

16/12/14

Date

陳建良

Witness